

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of	:	Customer Number: 89518
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MOU-SHIUNG LIN, et al.	:	Confirmation Number: 6093
	:	
Application No.: 10/055,568	:	Group Art Unit: 2813
	:	
Filed: January 22, 2002	:	Examiner: MITCHELL, JAMES M.
	:	
For: CHIP PACKAGE WITH DIE AND SUBSTRATE	:	

RESPONSE/AMENDMENT

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

CERTIFICATE OF ELECTRONIC TRANSMISSION
I hereby certify that this correspondence is being electronically-
transmitted to the United States Patent and Trademark Office on
November 24, 2009,
/Michelle Melendez/

Michelle Melendez

Sir:

In response to the Office Action dated June 26, 2009, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 7 of this paper.

An **Appendix** is attached hereto with the status of the related applications.